

# YJ Planar Schottky Barrier Diode Die Specification

60V 2A, 40mil, Schottky barrier diode die based on silicon planar process  
Part No.: PSB040M060SS-280A

## Main Products Characteristics

- Average forward current:  $I_{F(AV)} = 2\text{ A}$
- Maximum operating junction temperature:  $T_j = 150\text{ }^\circ\text{C}$
- ESD rating: >8KV, per IEC61000-4-2 (Contact Discharge)
- Top metal: Ag



## Maximum Ratings

Parameter	Symbol	Rating
Repetitive peak reverse voltage	$V_{RRM}$	60 V
Average forward current	$I_{F(AV)}$	2 A
Non-repetitive peak surge current ( $t_p = 8.3\text{ ms}$ , halfwave, 1 cycle)	$I_{FSM}$	50 A
Storage temperature range	$T_{stg}$	-50 to +150 $^\circ\text{C}$
Maximum operating junction temperature	$T_j$	150 $^\circ\text{C}$

## Static Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Value	
		Spec	Typical
Reverse breakdown voltage $I_R = 1\text{ mA}$	$V_{BR}$	65 V	72V
Maximum forward voltage drop $I_F = 2\text{ A}$ Pulse Test: $t_p = 300\text{ }\mu\text{s}$ , $\delta \leq 2\%$	$V_F$	0.68V	0.64V
Maximum reverse current $V_R = V_{RRM}$ Pulse Test: $t_p = 300\text{ }\mu\text{s}$ , $\delta \leq 2\%$	$I_R$	50uA	5uA

## Device Schematics and Outline Drawing

The top view shows a square die with a central 'Active Area' surrounded by three concentric rings labeled 'First Ring', 'Second Ring', and 'Third Ring'. A 'Top Metal Pad' is located at the top. The cross-sectional view shows the 'Back Metal' at the bottom, followed by the 'Substrate', 'Guard Ring', 'Epi' layer, 'SiO2' layer, 'Schottky Barrier', and 'Top Metal' on top.

Die Thickness *	11 Mils
Die Size **	40 Mils
Top Metal Pad	36.5 Mils
Active Area	32.9 Mils
Top Metal	Ag
Back Metal	Ag

Note: 1 \* : Also can offer device with 8 mils thickness  
2 \*\*: Cutting street width is around 1.5 mils

## Important Notice

<p>Specification apply to die only. Actual performance may degrade when assembled.</p> <p><b>Yangjie Electronics</b> does not guarantee device performance after assembly. All operating parameters must be validated for each customer application by customer's technical experts.</p> <p>Data sheet information is subjected to change without notice.</p>	<p>Recommended Storage Environment:</p> <p>Store in original container, in dessicated nitrogen, with no contamination.</p> <p>Shelf life for parts stored in above condition is 2 years.</p> <p>If the storage is done in normal atmosphere shelf life is reduced to 6 months.</p>
---	--